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PATENT

co/c

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent No.: 6,798,641 B1

Issued: September 28, 2004

Inventors: Peter J. Hopper et al.

Application No.: 10/647,602

Filed: August 25, 2003

For: LOW COST, HIGH DENSITY
DIFFUSION DIODE-CAPACITOR

**REQUEST FOR CERTIFICATE OF
CORRECTION OF PATENT FOR PTO
MISTAKE UNDER 37 C.F.R. §1.322(a)**

353 Sacramento Street, Suite 2200
San Francisco, CA 94111
Telephone: (415) 772-4900
Facsimile: (415) 398-2890

**Certificate
OCT 19 2004
of Correction**

Commissioner for Patents
Attn: Decision and Certificate of Correction Branch
of the Patent Issue Division
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Attached in duplicate is form PTO-1050 with at least one copy being suitable for printing.

On September 28, 2004, the above-identified Letters Patent was issued by the U.S. Patent Office with the original informal drawings which were first filed with the patent application on August 25, 2003.

Applicant requests a Certificate of Correction for the reasons set forth below:

1. As stated above, this application was filed on August 25, 2003, with informal drawings.
2. On September 24, 2003, Applicant filed formal drawings in the application.

Atty Docket No.: NSC1-M3100

OCT 20 2004

3. On March 1, 2004, the PTO issued an Office Action that included an objection to the drawings. A proposed drawing correction or corrected drawings were required in reply to the Office Action.

4. On May 27, 2004, Applicant mailed a response to the March 1, 2004, Office Action. This response included a proposed amendment to the formal drawing that had been filed on September 24, 2003. A copy of the response filed on May 27, 2004 is attached herewith as Attachment I.

5. On June 22, 2004, the PTO issued a Notice of Allowability stating that the drawings filed on August 26, 2003, i.e. the informal drawings filed with the original application, were accepted by the Examiner.

6. On July 9, 2004, Applicant mailed a Submission of Corrected Formal Drawings. The Submission of Corrected Formal Drawings document, a copy of which is attached hereto as Attachment II, noted the drawing objection previously raised by the PTO and Applicant's response thereto. The document also stated:

"To ensure that formal drawings are utilized in publication of the patent document for this application, Applicant submits a new sheet of formal drawings herewith that corresponds to the earlier filed formal drawings with proposed drawing correction included."

Applicants date-stamped return receipt postcard indicates that this communication to the Patent Office was received in the Patent Office on July 16, 2004.

As evident from the above-stated paragraphs, Applicant timely filed formal drawings in the above-referenced application. Therefore, for the reasons listed above, Applicant respectfully requests a Certificate of Correction be issued in this application showing the formal drawings as filed in the PTO, and as attached hereto.

Please send the Certificate to:

Michael J. Pollock
STALLMAN & POLLOCK LLP
353 Sacramento Street, Suite 2200
San Francisco, CA 94111

NATIONAL SEMICONDUCTOR CORPORATION is the assignee. The Assignment was recorded on August 25, 2003, on Reel 014480, Frame 0119.

The Commissioner is hereby authorized to charge any deficiency in the fees filed, asserted to be filed or which should have been filed herewith (or with any paper hereafter filed in this application by this firm) to our Deposit Account No. 50-1703, under Order No. NSC1-M3100. **A duplicate copy of this sheet is enclosed.**

Respectfully submitted,

STALLMAN & POLLOCK LLP

Date: October 6, 2004

By: 
Michael J. Pollock (Reg. No. 29,098)

Attorneys for Applicant(s)



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent No.: 6,798,641 B1

Issued: September 28, 2004

Inventors: Peter J. Hopper et al.

Application No.: 10/647,602

Filed: August 25, 2003

For: LOW COST, HIGH DENSITY
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**REQUEST FOR CERTIFICATE OF
CORRECTION OF PATENT FOR PTO
MISTAKE UNDER 37 C.F.R. §1.322(a)**

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Commissioner for Patents
Attn: Decision and Certificate of Correction Branch
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Alexandria, VA 22313-1450

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2. On September 24, 2003, Applicant filed formal drawings in the application.

Atty Docket No.: NSC1-M3100

OCT -2 0 2004

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4. On May 27, 2004, Applicant mailed a response to the March 1, 2004, Office Action. This response included a proposed amendment to the formal drawing that had been filed on September 24, 2003. A copy of the response filed on May 27, 2004 is attached herewith as Attachment I.

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"To ensure that formal drawings are utilized in publication of the patent document for this application, Applicant submits a new sheet of formal drawings herewith that corresponds to the earlier filed formal drawings with proposed drawing correction included."

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As evident from the above-stated paragraphs, Applicant timely filed formal drawings in the above-referenced application. Therefore, for the reasons listed above, Applicant respectfully requests a Certificate of Correction be issued in this application showing the formal drawings as filed in the PTO, and as attached hereto.

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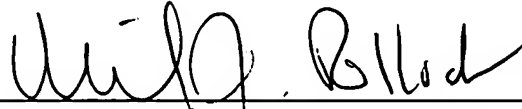
The Commissioner is hereby authorized to charge any deficiency in the fees filed, asserted to be filed or which should have been filed herewith (or with any paper hereafter filed in this application by this firm) to our Deposit Account No. 50-1703, under Order No. NSC1-M3100. **A duplicate copy of this sheet is enclosed.**

Respectfully submitted,

STALLMAN & POLLOCK LLP

Date: October 6, 2004

By:



Michael J. Pollock (Reg. No. 29,098)

Attorneys for Applicant(s)

OCT 20 2004

UNITED STATES PATENT AND TRADEMARK OFFICE

CERTIFICATE OF CORRECTION

Patent No.: 6,798,641 *B1*

Dated: September 28, 2004

Inventors: Peter J. Hopper et al.

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

MAILING ADDRESS OF SENDER:

MICHAEL J. POLLOCK
STALLMAN & POLLOCK LLP
353 SACRAMENTO STREET, SUITE 2200
SAN FRANCISCO, CA 94111

OCT 20 2004

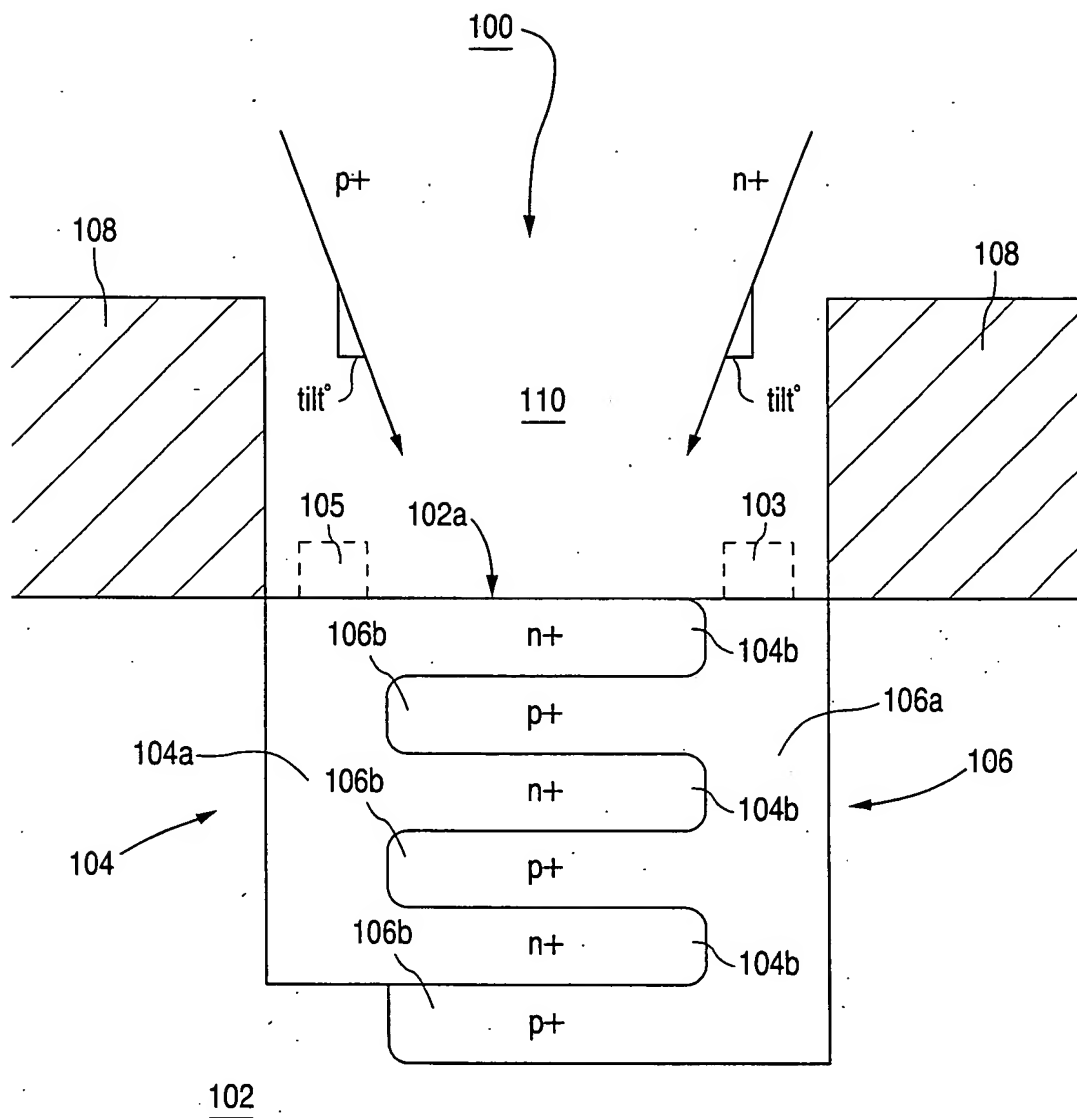


FIG. 1

UNITED STATES PATENT AND TRADEMARK OFFICE

CERTIFICATE OF CORRECTION

Patent No.: 6,798,641 B1

Dated: September 28, 2004

Inventors: Peter J. Hopper et al.

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STALLMAN & POLLOCK LLP
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SAN FRANCISCO, CA 94111

OCT 20 2004

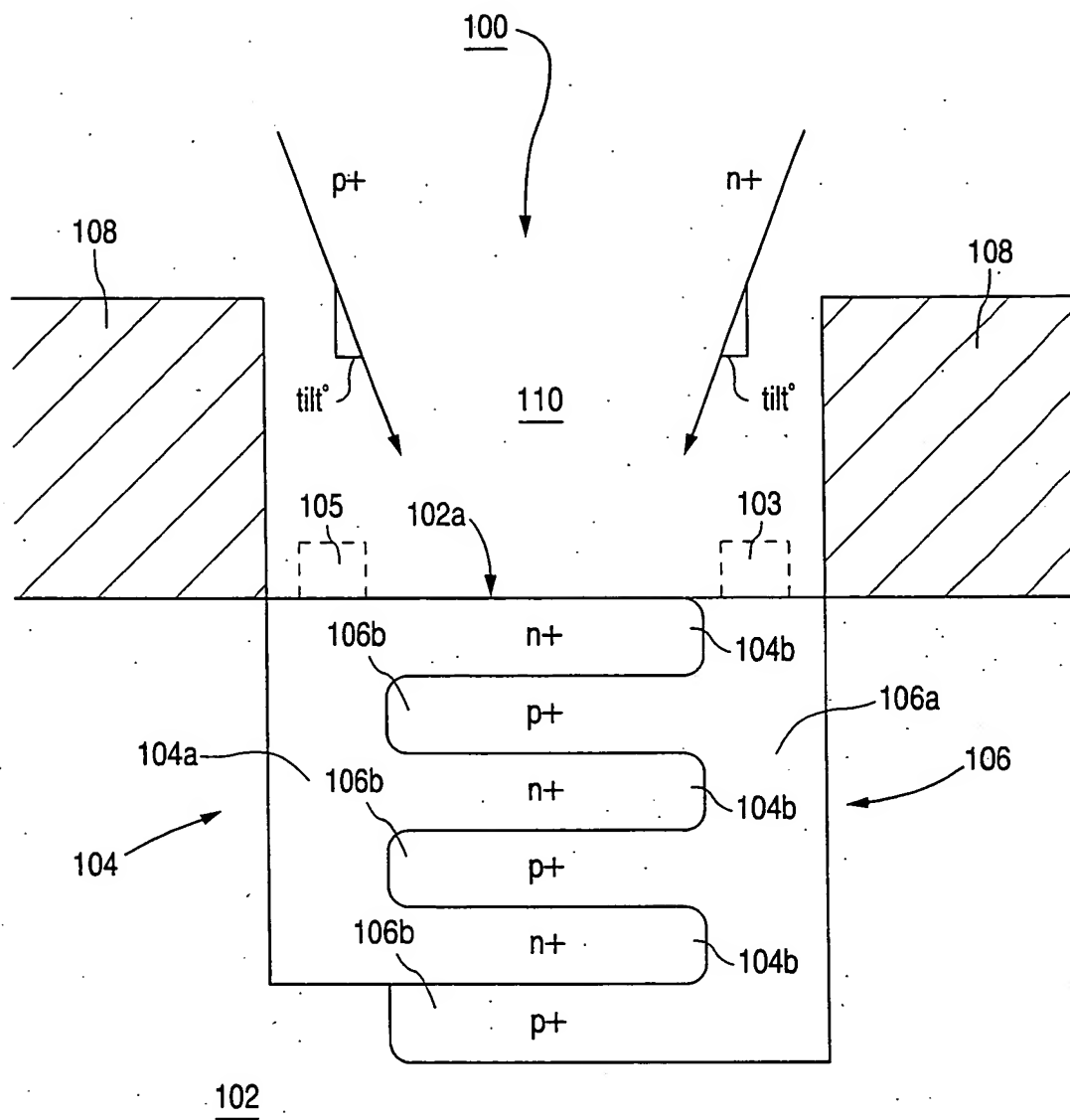
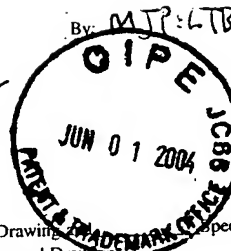


FIG. 1

Serial/Patent/Reg. No. 10/647,602
 In the Matter of the Application of: Peter J. Hopper
 Title/Mark: Low Cost, High Density Diffusion Diode-Capacitor
 Date Mailed: 05/27/04

S&P File No. NSC1-M3100By: MJP:LTBDue Date: 06/01/04

The following has been received in the U.S. Patent and Trademark Office on the date stamped hereon:

- | | |
|--|---|
| <input checked="" type="checkbox"/> Transmittal Letter <u>x2</u> | <input type="checkbox"/> Trademark (Use) Appln., Drawing _____ specimens |
| <input type="checkbox"/> Patent Application _____ | <input type="checkbox"/> ITU Trademark Application and Drawing _____ |
| <input type="checkbox"/> _____ pgs. specification including _____ pgs. claims | <input type="checkbox"/> _____ Request for Extension to Time (trademark) |
| <input checked="" type="checkbox"/> Drawings <u>1</u> sheets _____ formal <input checked="" type="checkbox"/> informal | <input type="checkbox"/> (Notice of Allowance: _____) |
| <input type="checkbox"/> Oath/Declaration | <input type="checkbox"/> Statement of Use/Amendment to Allege Use |
| <input type="checkbox"/> Assignment w/ Form PTO-1595 | <input type="checkbox"/> Section 8 & 15 Declaration |
| <input type="checkbox"/> Power of Attorney | <input type="checkbox"/> Trademark Renewal Application and _____ Specimen |
| <input type="checkbox"/> Small Entity Declaration | <input type="checkbox"/> Opposition to _____ |
| <input checked="" type="checkbox"/> Deposit Account Authorization (in duplicate) | <input type="checkbox"/> Petition for Cancellation |
| <input type="checkbox"/> Information Disclosure Statement, PTO-1449 w/ _____ references | <input checked="" type="checkbox"/> Certificate of Mailing |
| <input type="checkbox"/> Check \$ _____ | <input type="checkbox"/> Express Mail Certificate No. _____ |
| <input checked="" type="checkbox"/> Amendment/Response <u>To Office Action mailed</u> | <input type="checkbox"/> Certificate under §3.73(b) |
| <input type="checkbox"/> Request for Extension of Time (_____ months)(patent) <u>3/1/04</u> | <input type="checkbox"/> Certificate of Correction (PTO Form 1050) |
| <input type="checkbox"/> Terminal Disclaimer | <input type="checkbox"/> Petition for: _____ |
| <input type="checkbox"/> Notice of Appeal | <input type="checkbox"/> Other: _____ |
| <input type="checkbox"/> Appeal Brief (in triplicate) | _____ |
| <input type="checkbox"/> Letter to Official Draftsman | _____ |
| <input type="checkbox"/> Issue Fee Transmittal | _____ |
| <input type="checkbox"/> Maintenance Fee Transmittal | _____ |
| <input checked="" type="checkbox"/> Request for <u>Change of Address</u> | _____ |

COPY

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

Peter J. Hopper

Application No.: 10/647,602

Filed: August 25, 2003

For: LOW COST, HIGH DENSITY
DIFFUSION DIODE-CAPACITOR

Group Art Unit: 2831

Examiner: Nguyen T. Ha

**CHANGE OF ATTORNEY OR AGENT'S
ADDRESS IN APPLICATION
(37 CFR 1.8(a))**353 Sacramento Street, Suite 2200
San Francisco, CA 94111
(415) 772-4900Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450**CERTIFICATE OF MAILING**I hereby certify that this correspondence is being deposited
with the United States Postal Service as First Class Mail in an
envelope, addressed to: Commissioner for Patents, P.O.
Box 1450 Alexandria, VA 22313-1450 on May 27, 2004.
STALLMAN & POLLOCK LLPDated: 05/27/04By: 

Lana T. Brenner

Sir:

Please send all correspondence for this application to:

STALLMAN & POLLOCK LLP
Attn: Michael J. Pollock
353 Sacramento Street, Suite 2200
San Francisco, CA 94111
Customer No.: 28584

Please direct all telephone calls to:

Michael J. Pollock
Telephone: (415) 772-4900
Facsimile: (415) 398-2890

Respectfully submitted,

STALLMAN & POLLOCK LLP

Dated: May 27, 2004By: Michael J. Pollock
Reg. No. 29,098

Attorneys for Applicant(s)

Atty Docket No.: NSC1-M3100 [P05660]

COPY

STALLMAN & POLLOCK LLP
353 Sacramento Street, Suite 2200
San Francisco, CA 94111
(415) 772-4900

In re Patent Application of: Peter J. Hopper

Atty Docket No. NSC1-M3100 [P05660]

Application No.: 10/647,602

Filed: August 25, 2003

For: LOW COST, HIGH DENSITY DIFFUSION DIODE-CAPACITOR

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Transmittal herewith is an amendment in the above-identified application.

The fee has been calculated as shown below.

	CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NO. PREVIOUSLY PAID FOR	PRESENT EXTRA	RATE	ADDITIONAL FEE
TOTAL	6	MINUS	20		x \$18 =	\$0.00
INDEP.	2	MINUS	3		x \$86 =	\$0.00
FIRST PRESENTATION OF MULTIPLE DEP CLAIMS					+ \$290	\$
					TOTAL	\$0.00

Small Entity 50% Filing Fee Reduction (if applicable)

\$

- * If the entry in Col. 1 is less than the entry in Col. 2, write "0" in Col. 3
** If the "Highest Number Previously Paid For" IN THIS SPACE is less than 20, write "20" in this space.
*** If the "Highest Number Previously Paid For" IN THIS SPACE is less than 3, write "3" in this space. The "Highest Number Previously Paid For" (Total or Independent is the highest number found from the equivalent box in Col. 1 of a prior amendment or the number of claims originally filed.)

- ☒ No additional fee is required.
- ☐ A check in the amount of \$_____ is attached.
- ☒ Please charge any additional fees, including any fees necessary for extensions of time or credit overpayment to Deposit Account No. 50-1703, under Order No. NSC1-M3100.
A duplicate copy of this sheet is enclosed.
- ☐ Petition for extension of time. The undersigned attorney of record hereby petitions for an extension of time pursuant to 37 C.F.R. § 1.136(a), as may be required, to file this response.

STALLMAN & POLLOCK LLP

Dated: May 27, 2004

By:



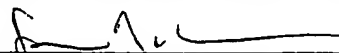
Michael J. Pollock (Reg. No. 29,098)
Attorneys for Applicant(s)

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on May 27, 2004.

Dated: 05/27/04

By:



Lana T. Brenner

COPY

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

Peter J. Hopper et al.

Application No.: 10/647,602

Filed: August 25, 2003

For: LOW COST, HIGH DENSITY
DIFFUSION DIODE-CAPACITOR

Group Art Unit: 2831

Examiner: Nguyen T. Ha

**RESPONSE TO OFFICE ACTION
MAILED MARCH 1, 2004**353 Sacramento St., Suite 2200
San Francisco, CA 94111
(415) 772-4900Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1650**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope, addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1650, on May 27, 2004.

STALLMAN & POLLOCK LLP

Dated: 05/27/04

By:

Lana T. Brenner

Sir:

In response to the Office Action mailed March 1, 2004, please amend the above-identified application as follows:

Amendments to the Specification are reflected in a substitute paragraph provided on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims that begins on page 3 of this paper.

A purposed amendments to the Drawing is enclosed herewith.

Remarks/Arguments begin on page 5 of this paper.

AMENDMENTS TO THE SPECIFICATION

Please amend the paragraph that begins at page 3, line 17 of the specification to read as follows:

Following the formation of the inter-digitated capacitor structure, a layer of aluminum or other conductive interconnect material is deposited over the capacitor structure and etched to provide a first conductive [contact] electrode 103 to the N-type dopant region 104 [(see Fig. 1)] and a second conductive [contact] electrode 105 to the P-type dopant region 106 [(see Fig. 1)]. The first conductive electrode 103 and the second conductive electrode 105 are shown in dashed lines in Fig. 1.

AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions, and listings, of claims in the application.

Listing of Claims

1. (Currently amended) A multiple-layer diffusion junction capacitor structure comprising:
an N-type region formed in a semiconductor substrate and having an N-type vertical portion and a plurality of spaced-apart N-type fingers that extend from the N-type vertical portion; and
a P-type region formed in a semiconductor substrate and having a P-type vertical portion and a plurality of spaced-apart P-type fingers that extend from the P-type vertical portion, and
wherein the N-type fingers and the P-type fingers are inter-digitated and in direct contact.
2. (Currently amended) A multiple-layer diffusion junction capacitor structure as in claim 1, and further comprising:
a first conductive [contact] electrode formed on an upper surface of the N-type region; and
a second conductive electrode formed on an upper surface of the P-type region.
3. (Original) A multiple-layer diffusion junction capacitor structure as in claim 2, and wherein both the first conductive electrode and the second conductive electrode comprise aluminum.
4. (Original) A method of forming an N-layer junction capacitor structure in a semiconductor substrate, wherein N is an integer, the method comprising:

forming a patterned mask on an upper surface of the semiconductor substrate, the patterned mask having at least one opening formed therein to expose an upper surface area of the semiconductor substrate;

forming a sequence of N alternating implants of P-type dopant and of N-type dopant at negative and positive implant angles, respectively, for a particular conductivity type dopant each implant being performed with a different energy and implant dose, thereby resulting in N inter-digitated layers of P-type dopant and N-type dopant formed in a semiconductor substrate; and

forming a first conductive electrode in electrical contact with the P-type dopant layers and a second conductive electrode in electrical contact with the N-type dopant layers.

5. (Original) A method as in claim 4, and wherein the patterned mask comprises silicon oxide.

6. (Currently amended) A method as in claim 4, and wherein the first and second conductive electrodes comprise [alumimun] aluminum.

REMARKS/ARGUMENTS

Reconsideration of the above-identified application is requested in view of the remarks that follow.

In the March 1, 2004, Office Action in this application, the Examiner rejected Claims 2 and 3 because of inconsistency between the language of original Claim 2 and the language of original Claim 3 with respect to the term "first conductive electrode."

As indicated above, Claim 2 has been amended to recite a "first conductive electrode" thereby eliminating the inconsistency between Claims 2 and 3.

The Examiner objected to the drawings under 37 CFR 1.83(a), stating that the claimed "first conductive contact" and "second conductive contact" are not showing in the drawings.

Attached hereto is a proposed amendment to Fig. 1 identifying a first conductive electrode 103 and a second conductive electrode 105, both of which appear in dashed lines in original Fig. 1. In addition, as indicated above, Applicant has amended the specification to more specifically recite the first conductive electrode 103 and the second conductive electrode 105.

The Examiner has rejected Claim 1 under 35 U.S.C. 102(b) as being anticipated by the Winters '964 patent. For the reasons set forth below, it is submitted that amended Claim 1 patentably distinguishes over the Winters teaching.

Specifically, as indicated in Fig. 1 of the application, the interdigitated capacitor structure recited in Claim 1 is formed "in" a semiconductor structure, as opposed to the stacked gate capacitor structure taught by Winters which is formed "on" a semiconductor substrate.

Furthermore, the alternating N-type and P-type regions disclosed by Winters are separated from one another by intervening dielectric material. In Applicant's Claim 1 invention, as shown in Fig. 1, as a result of the fabrication technique of alternating N+ implants and P+ implants, the N+ fingers 104b and the P+ fingers 106b are interdigitated, that is, they are in direct contact with one another. Claim 1 has been amended to clarify this feature of the Claim 1 invention.

For these reasons, it is believed that subject matter recited in Claim 1 patentably distinguishes over the Winters reference.

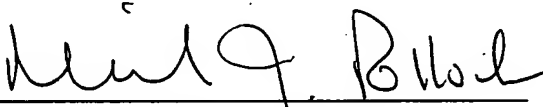
Although the Examiner has rejected Claims 2 and 3 under 35 U.S.C. 103(a) as being unpatenable over Winters in view of the Rao et al. '014 patent, since it is believed that amended Claim 1 distinguishes over the prior art, and since Claims 2 and 3 depend from Claim 1, it is submitted that Claims 2 and 3 also patentably distinguish over the prior art.

For the reasons set forth above, Applicant believes that all claims currently pending in this application patentably distinguish over the prior art. Therefore, it is requested that this amendment be entered and that the application be passed to allowance.

Respectfully submitted,

STALLMAN & POLLOCK LLP

Dated: May 27, 2004

By: 
Michael J. Pollock
Reg. No. 29,098

Attorneys for Applicant(s)

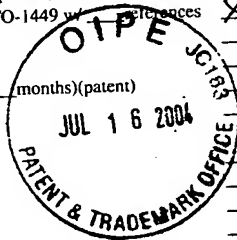


COPY

Serial/Patent/Reg. No. 10/647,602 3&P File No. NSC1-M3100 By: MJP:LTP
 In the Matter of the Application of: Peter J. Hopper et al.
 Title/Mark: Low Cost, High Density Diffusion Diode Capacitor
 Date Mailed: 07/09/04 Due Date: 09/22/04

The following has been received in the U.S. Patent and Trademark Office on the date stamped hereon:

<input checked="" type="checkbox"/> Transmittal Letter	<input type="checkbox"/> Trademark (Use) Appln., Drawing and _____ Specimens
<input type="checkbox"/> Patent Application _____	<input type="checkbox"/> ITU Trademark Application and Drawing
<input type="checkbox"/> _____ pgs. specification including _____ pgs. claims	<input type="checkbox"/> Request for Extension to Time (trademark)
<input checked="" type="checkbox"/> Drawings <u>1</u> sheets <input checked="" type="checkbox"/> formal <input type="checkbox"/> informal	<input type="checkbox"/> (Notice of Allowance: _____)
<input type="checkbox"/> Oath/Declaration	<input type="checkbox"/> Statement of Use/Amendment to Allege Use
<input type="checkbox"/> Assignment w/ Form PTO-1595	<input type="checkbox"/> Section 8 & 15 Declaration
<input type="checkbox"/> Power of Attorney	<input type="checkbox"/> Trademark Renewal Application and _____ Specimen
<input type="checkbox"/> Small Entity Declaration	<input type="checkbox"/> Opposition to _____
<input type="checkbox"/> Deposit Account Authorization (in duplicate)	<input type="checkbox"/> Petition for Cancellation
<input type="checkbox"/> Information Disclosure Statement, PTO-1449 w/ _____ Citations	<input checked="" type="checkbox"/> Certificate of Mailing
<input type="checkbox"/> Check \$ _____	<input type="checkbox"/> Express Mail Certificate No. _____
<input type="checkbox"/> Amendment/Response	<input type="checkbox"/> Certificate under §3.73(b)
<input type="checkbox"/> Request for Extension of Time (____ months)(patent)	<input type="checkbox"/> Certificate of Correction (PTO Form 1050)
<input type="checkbox"/> Terminal Disclaimer	<input type="checkbox"/> Petition for _____
<input type="checkbox"/> Notice of Appeal	<input type="checkbox"/> Other: _____
<input type="checkbox"/> Appeal Brief (in triplicate)	_____
<input type="checkbox"/> Letter to Official Draftsman	_____
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In re Patent Application of

Peter J. Hopper et al.

Application No.: 10/647,602

Filed: August 25, 2003

For: LOW COST, HIGH DENSITY
DIFFUSION DIODE-CAPACITOR

Confirmation No.: 2813

Group Art Unit: 2831

Examiner: Ha, Nguyen T

**SUBMISSION OF CORRECTED
FORMAL DRAWINGS**

353 Sacramento Street, Suite 2200
San Francisco, CA 94111
(415) 772-4900

Mail Stop PGPUB Drawings
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Alexandria, VA 22313-1450

CERTIFICATE OF MAILING

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STALLMAN & POLLOCK LLP

Dated 7/9/04

By: 

Lana T. Brenner

Sir:

Enclosed herewith is one (1) sheet of formal drawing that Applicant submits for publication with the formal patent document for the above-referenced application.

This application was filed on August 25, 2003, with informal drawings.

On March 1, 2004, the Examiner issued an Office Action in the application objecting to the drawings as failing to show every feature of the invention specified in the claims. The Examiner further stated: "A proposed drawing correction or corrected drawings are required in reply to the Office Action to avoid abandonment of the application. The objection to the drawings will not be held in abeyance."

On May 27, 2004, Applicant filed a response to the Office Action mailed March 1, 2004. The response included a proposed amendment to Figure 1.

On June 22, 2004, the Examiner issued a Notice of Allowance in the application, stating: "The drawings filed on 26 August 2003 are accepted by the Examiner." As stated above, the drawings filed with the original application on 25 August 2003 were informal drawings. It was assumed that the informal drawings were superseded by the formal drawings filed on 27 May 2004 (with the proposed correction).

To ensure that formal drawings are utilized in publication of the patent document for this application, Applicant submits a new sheet of formal drawings herewith that corresponds to the earlier filed formal drawings with proposed drawing correction included.

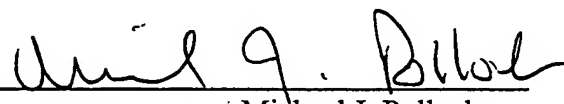
Should there be any questions regarding this matter, it is requested that the undersigned be contacted immediately at (415) 772-4900.

Respectfully submitted,

STALLMAN & POLLOCK LLP

Dated: July 9, 2004

By: _____


Michael J. Pollock
Reg. No. 29,098

Attorneys for Applicant(s)

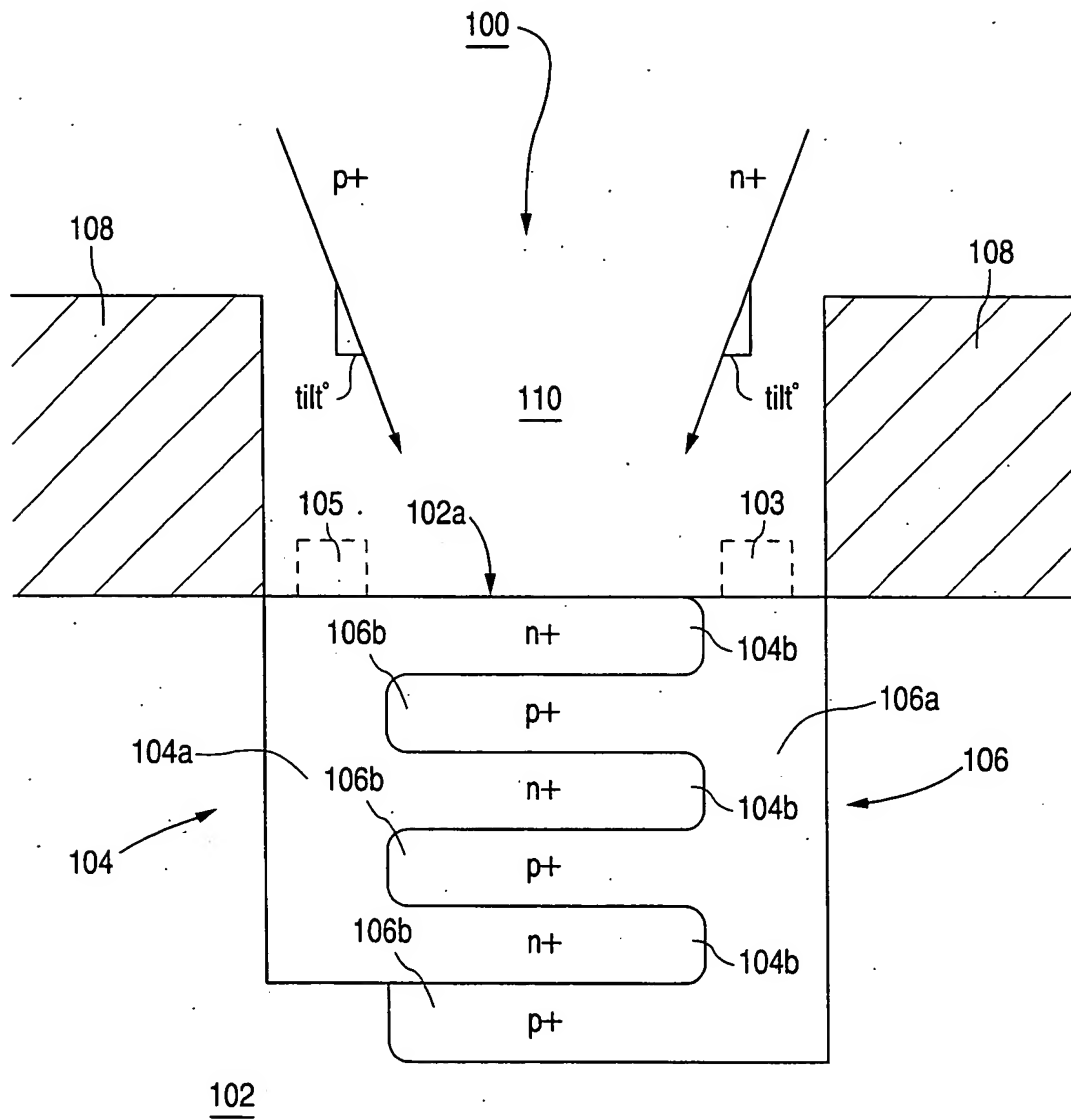


FIG. 1

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